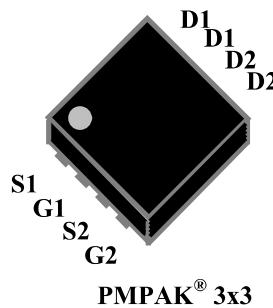


AP0803QD

N-Channel Power MOSFET

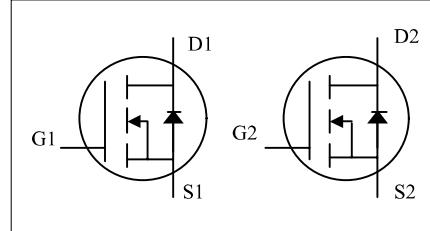
- ▼ Simple Drive Requirement
- ▼ Low On-resistance
- ▼ Fast Switching Performance
- ▼ RoHS Compliant & Halogen-Free



BV_{DSS}	30V
$R_{DS(ON)}$	9mΩ
I_D	20A

Description

AP0803QD series are from All Power innovative design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.



Absolute Maximum Ratings@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_A = 25^\circ\text{C}$	Drain Current, $V_{GS} @ 10\text{V}^3$	20	A
$I_D @ T_A = 70^\circ\text{C}$	Drain Current, $V_{GS} @ 10\text{V}^3$	14.1	A
I_{DM}	Pulsed Drain Current ¹	75	A
$P_D @ T_A = 25^\circ\text{C}$	Total Power Dissipation	20	W
E_{AS}	Single Pulse Avalanche Energy ⁴	65	mJ
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient ³	6.25	°C/W

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Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	30	-	-	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance ²	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=10\text{A}$	-	9	11.5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=5\text{A}$	-	-	18	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=1\text{mA}$	1	-	3	V
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{D}}=10\text{A}$	-	40	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=24\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	10	uA
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
Q_{g}	Total Gate Charge	$I_{\text{D}}=5\text{A}$	-	14	22.4	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=15\text{V}$	-	4.4	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge		-	5.4	-	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{DS}}=15\text{V}$	-	9	-	ns
t_{r}	Rise Time	$I_{\text{D}}=1\text{A}$	-	8	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time	$R_{\text{G}}=3.3\Omega$	-	29	-	ns
t_{f}	Fall Time	$V_{\text{GS}}=10\text{V}$	-	9	-	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	790	1280	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=15\text{V}$	-	225	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	160	-	pF
R_{g}	Gate Resistance	$f=1.0\text{MHz}$	-	2.5	5	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_{\text{S}}=1.7\text{A}$, $V_{\text{GS}}=0\text{V}$	-	-	1.2	V
t_{rr}	Reverse Recovery Time	$I_{\text{S}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$,	-	11	-	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100\text{A}/\mu\text{s}$	-	4	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in² copper pad of FR4 board, $t \leq 10\text{sec}$; $135^\circ\text{C}/\text{W}$ when mounted on Min. copper pad.
- 4.Starting $T_j=25^\circ\text{C}$, $V_{\text{DD}}=15\text{V}$, $L=0.5\text{mH}$, $R_{\text{G}}=25\Omega$

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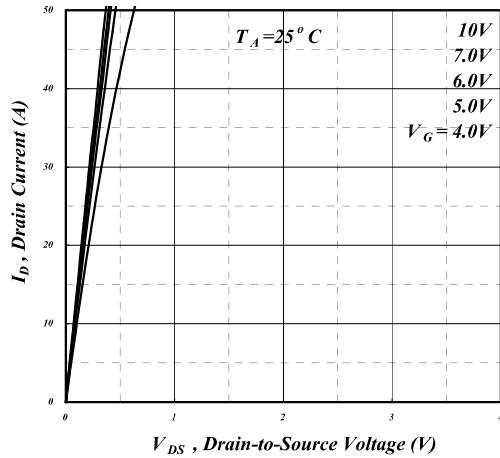


Fig 1. Typical Output Characteristics

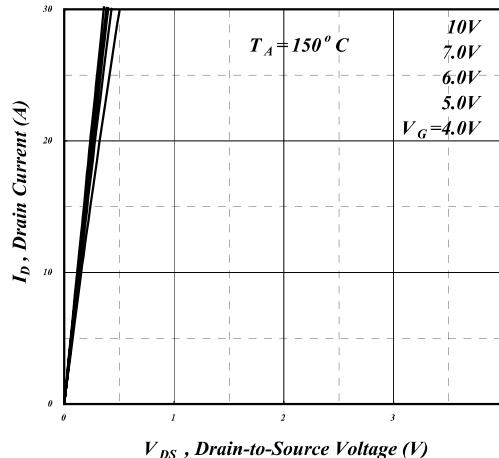


Fig 2. Typical Output Characteristics

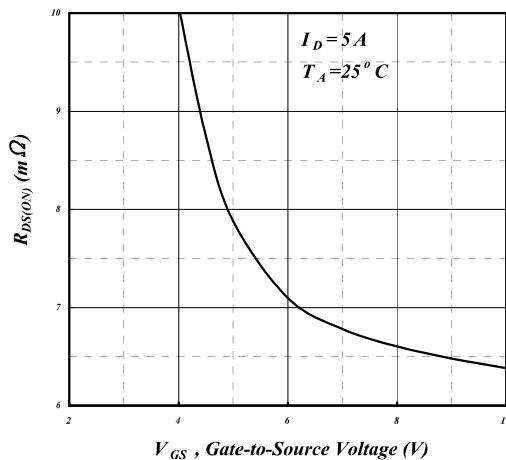


Fig 3. On-Resistance v.s. Gate Voltage

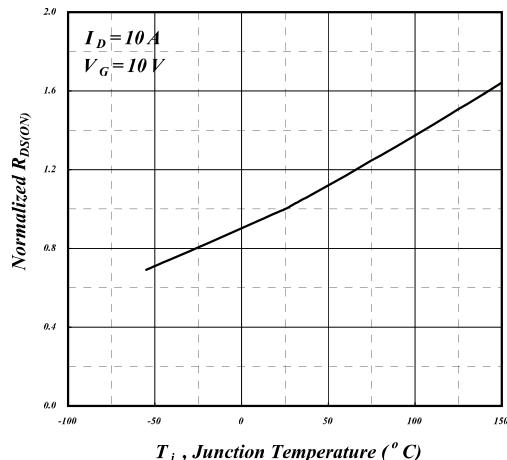


Fig 4. Normalized On-Resistance v.s. Junction Temperature

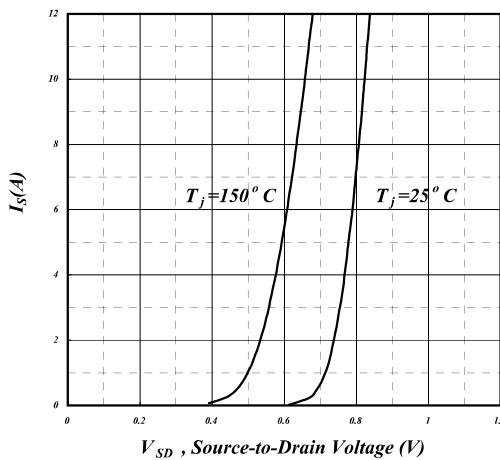


Fig 5. Forward Characteristic of Reverse Diode

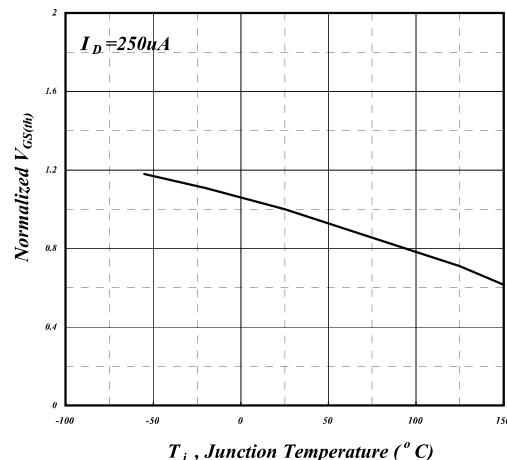


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

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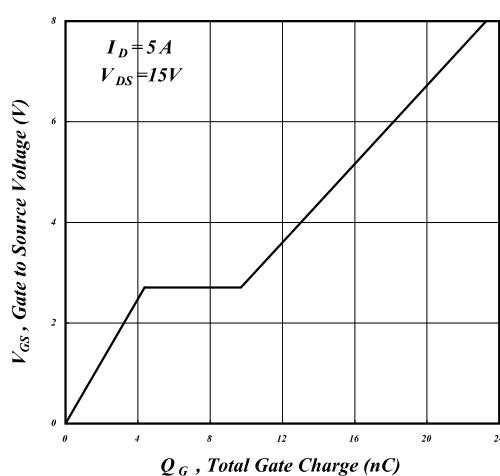


Fig 7. Gate Charge Characteristics

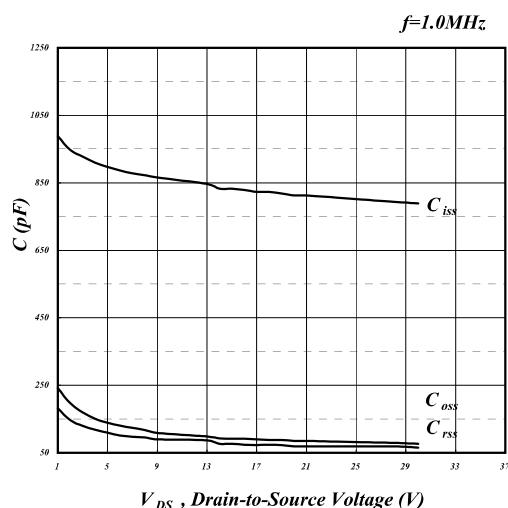


Fig 8. Typical Capacitance Characteristics

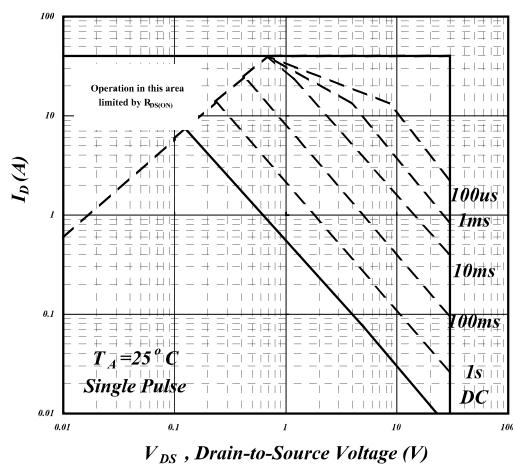


Fig 9. Maximum Safe Operating Area

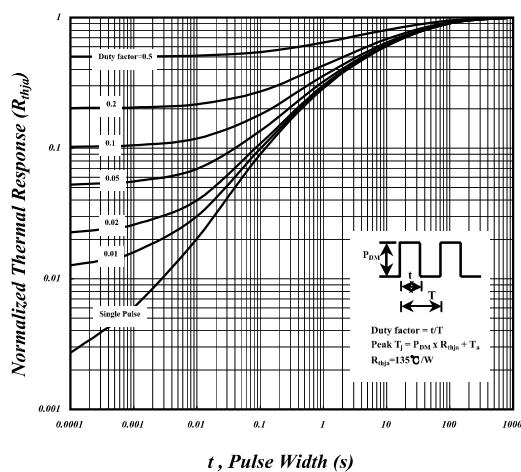


Fig 10. Effective Transient Thermal Impedance

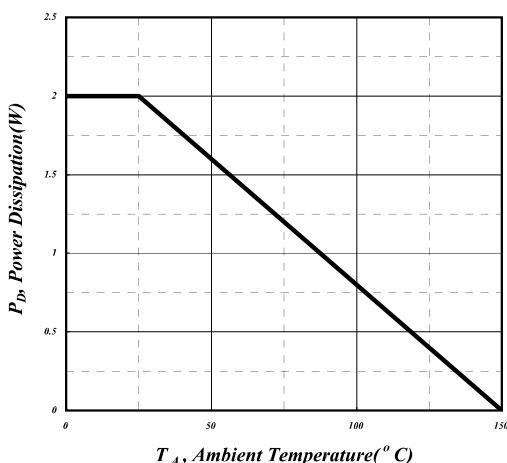


Fig 11. Total Power Dissipation

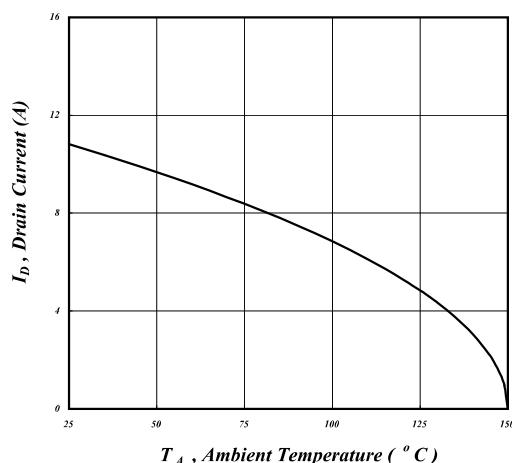
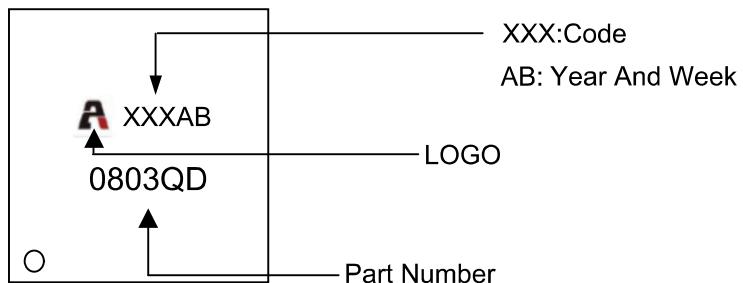


Fig 12. Drain Current v.s. Ambient Temperature

MARKING INFORMATION



AP0803QD

N-Channel Power MOSFET

PACKAGE OUTLINE DIMENSIONS